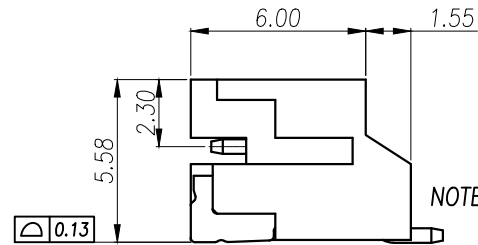
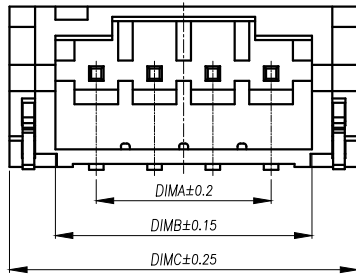
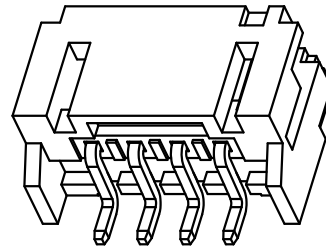
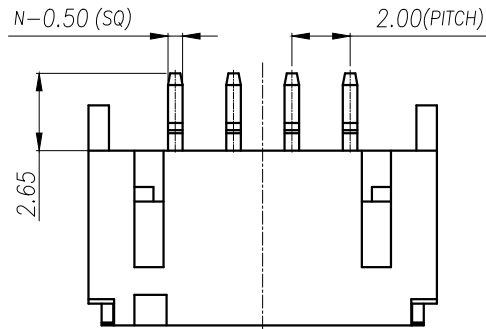
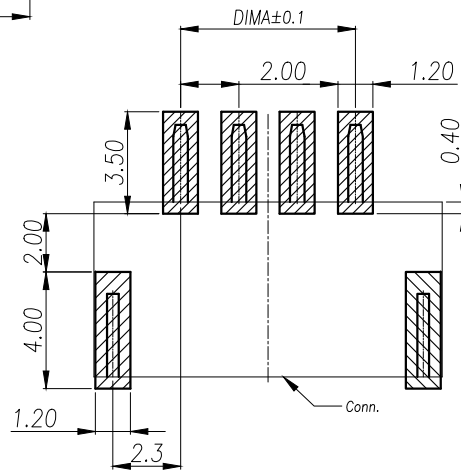


PRELIMINARY
DESIGN IS SUBJECT
TO CHANGE WITHOUT
PRIOR NOTICE



NOTES:

- 1.Working temp:-25°C~85°C.
- 2.Voltage rating:100V AV/DC(rms)
- 3.Contact resistance:20mΩ max.
- 4.Insulation resistance:1000MΩ min.
- 5.Current rating:2A AV/DC
- 6.Withstanding Voltage:800V AC/minute
- 7.Pin Retention Force:15N min.
- 8.Housing material:LCP UL94-V0,Natural
- 9.Terminal materl:Brass,
plating Ni 50u" min , plating Tin 100u"min.
- 10.Solder tab material:Brass,
plating Ni 50u" min , plating Tin 100u"min.



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)

SMT SOLDER AREA

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyconn Electronics Co.,Ltd		
TOLERANCE UNLESS OTHERWISE SPECIFIED				
.X±0.35	.X*± 5°	APR. Alex	TITLE: WAFER 2.0mm H6.0mm 180° DIP	
.XX±0.25	.X*± 3°	CHK. Jack	DWG NO. XY-BNB-PH-K-S	
.XXX±0.15	.XX*± 1°	DRA. Can	PROJ.	CUSTOMER DRAWING
SIZE A4	SCALE 1:1	SHEET 1/1	REV. A	

Part No	PIN	A	B
XY-B2B-PH-K-S	2	2	6
XY-B3B-PH-K-S	3	4	8
XY-B4B-PH-K-S	4	6	10
XY-B5B-PH-K-S	5	8	12
XY-B6B-PH-K-S	6	10	14
XY-B7B-PH-K-S	7	12	16
XY-B8B-PH-K-S	8	14	18
XY-B9B-PH-K-S	9	16	20
XY-B10B-PH-K-S	10	18	22
XY-B11B-PH-K-S	11	20	24
XY-B12B-PH-K-S	12	22	26
XY-B13B-PH-K-S	13	24	28
.....	...	...	...
XY-B20B-PH-K-S	20	(20-1)*2	(20+1)*2